

Special Issue

New Horizons and Applications for Big Data Analysis and Smart Computing

Message from the Guest Editor

Cloud and edge computing, along with mobile computing, form the backbone of the Internet of Things (IoT), enabling the seamless connectivity and intelligence of smart devices. Cloud computing provides robust, scalable infrastructure that supports the massive data generated by IoT devices, offering centralized processing power and storage. Mobile computing complements this by offering portability and direct interaction with users through smartphones and tablets, allowing for real-time data access and control.

In summary, the integration of cloud/edge computing with mobile computing and IoT technologies is driving innovation, enhancing efficiency, and transforming industries by harnessing the power of connected devices and data-driven insights

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As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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